

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE60P40F uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

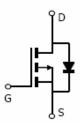
General Features

- V_{DS} =-60V, I_{D} =-40A $R_{DS(ON)}$ <35m Ω @ V_{GS} =-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!



Schematic diagram



Marking and pin assignment



TO-220F top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE60P40F	NCE60P40F	TO-220F	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	-40	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-28.3	Α
Pulsed Drain Current (Note 1)	I _{DM}	160	Α
Maximum Power Dissipation	P _D	37	W
Derating factor		0.25	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	168	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$

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NCE60P40F

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	4.0	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=-250\mu A$	-2.0	-2.6	-3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	31	35	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	-	20	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	\/ - 20\/\/ -0\/	-	2049	-	PF
Output Capacitance	Coss	V_{DS} =-30V, V_{GS} =0V, F=1.0MHz	-	112.7	-	PF
Reverse Transfer Capacitance	C _{rss}	r=1.0lvln2	-	88.7	-	PF
Switching Characteristics (Note 4)	<u> </u>					
Turn-on Delay Time	t _{d(on)}		-	13	-	nS
Turn-on Rise Time	t _r	V_{DD} =-30 V , I_{D} =-20 A	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =3 Ω	-	39	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Qg	V - 20VI - 20A	-	35.1	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-30V, I_{D} =-20A,	-	9	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =-10V	-	7.9	-	nC
Drain-Source Diode Characteristics	<u> </u>					
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	-45	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = -20A	-	-	40	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	-	70	nC

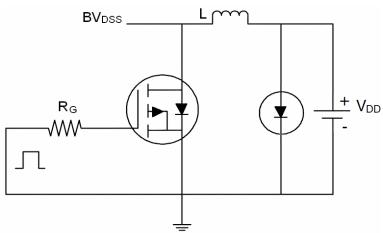
Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature}.$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** E_{AS} condition: $Tj=25^{\circ}C$, $V_{DD}=-30V$, $V_{G}=-10V$,L=0.5mH, $Rg=25\Omega$

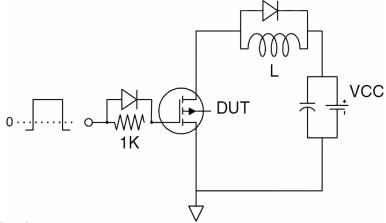


Test Circuit

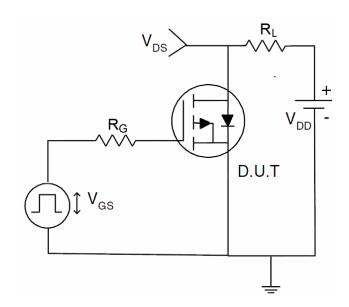
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

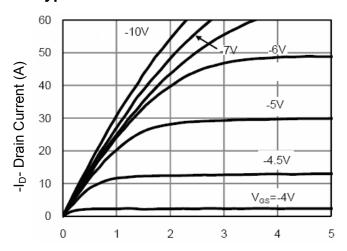


3) Switch Time Test Circuit



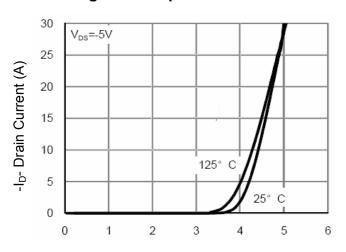


Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



-Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

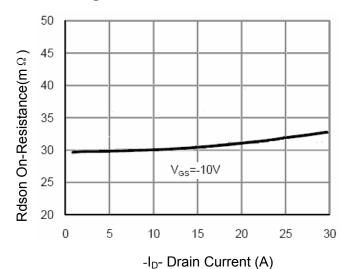


Figure 3 Rdson- Drain Current

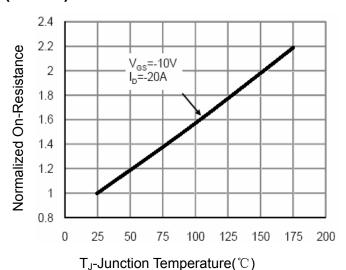


Figure 4 Rdson-JunctionTemperature

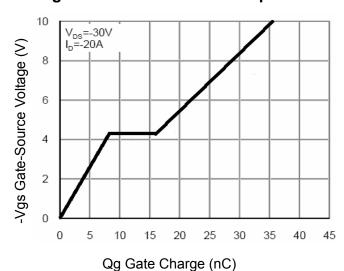
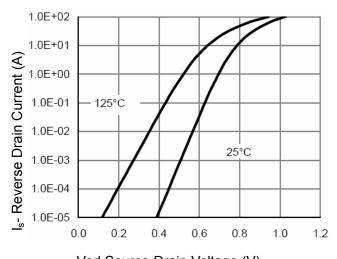


Figure 5 Gate Charge



-Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



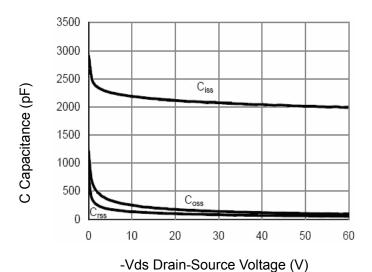
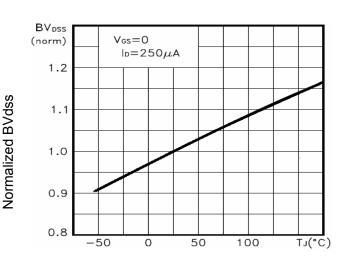


Figure 7 Capacitance vs Vds



 T_J -Junction Temperature (°C) Figure 9 BV_{DSS} vs Junction Temperature

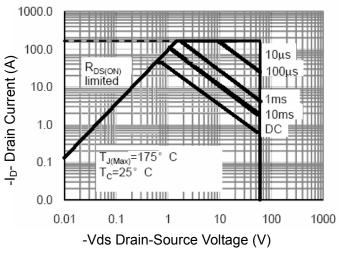
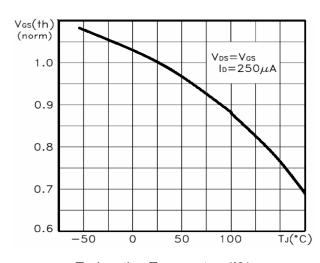
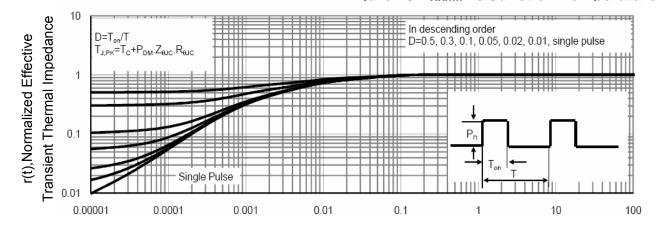


Figure 8 Safe Operation Area



T_J-Junction Temperature(°C)

Figure 10 V_{GS(th)} vs Junction Temperature

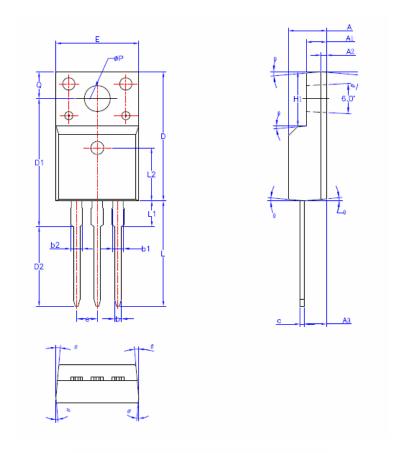


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220F Package Information



SYMBOL	MIN	NOM	MAX		
Α	4.50	4.70	4.83		
A1	2.34	2.54	2.74		
A2		0.70 R	ΞF		
A3	2.56	2.76	2.93		
b	0.70	_	0.90		
b1	1.18	_	1.38		
b2	_	_	1.47		
С	0.45	0.50	0.60		
D	15.67	15.87	16.07		
D1	15.55	15.75	15.95		
D2	9.60	9.80	10.0		
Е	9.96	10.16	10.36		
е	2				
H1	6.48	6.68	6.88		
L	12.68	12.98	13.28 3.50		
L1	-	_			
L2	(
ØΡ	3.08	3.18	3.28		
Q	3.20	_	3.40		
θ 1	1*	3°	5*		

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NCE60P40F

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